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2SC1568

Silicon NPN epitaxial planar type

For low-voltage type medium output power amplification
Complementary to 2SA0900

■ Features

- Low collector-emitter saturation voltage $V_{CE(sat)}$
- Satisfactory operation performances and high efficiency with a low-voltage power supply
- TO-126B package which incorporates a unique construction enabling installation to the heat sink without using insulation parts

■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	V_{CBO}	18	V
Collector-emitter voltage (Base open)	V_{CEO}	18	V
Emitter-base voltage (Collector open)	V_{EBO}	5	V
Collector current	I_C	1	A
Peak collector current	I_{CP}	2	A
Collector power dissipation	P_C	1.2	W
Junction temperature	T_j	150	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

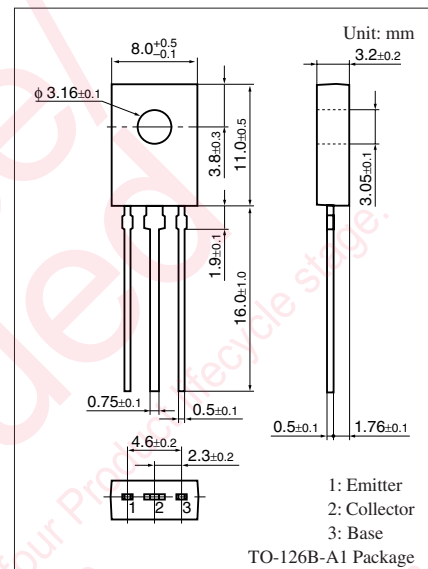
■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

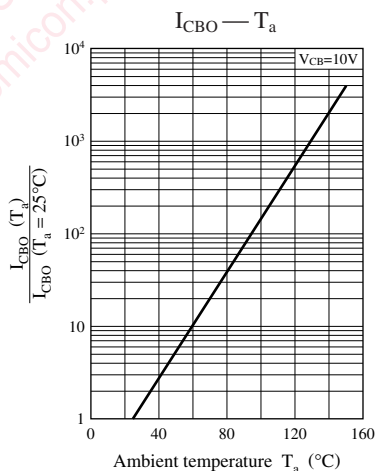
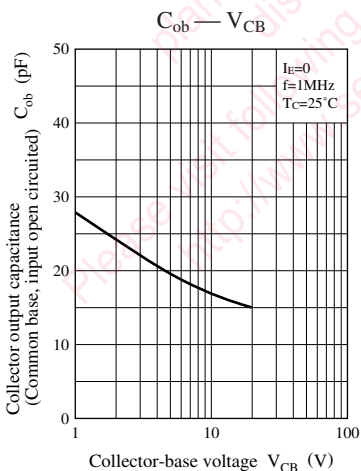
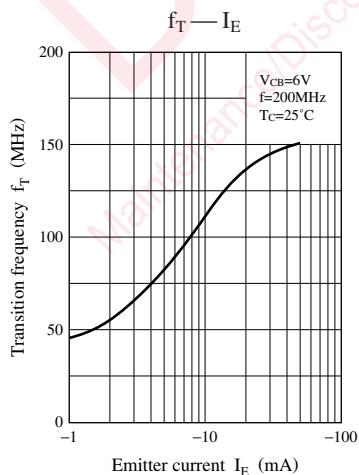
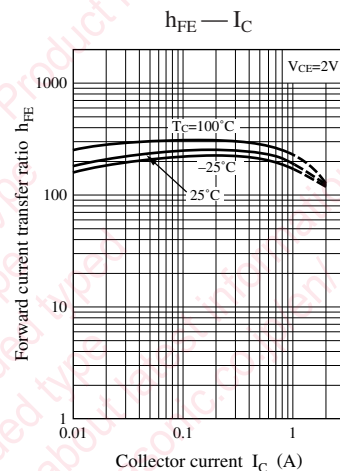
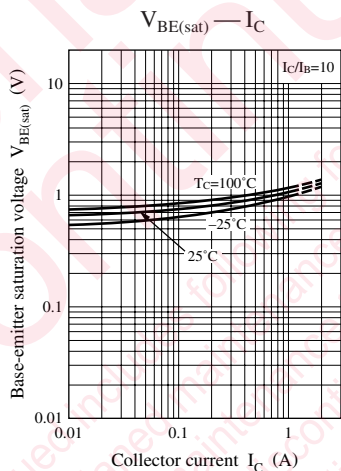
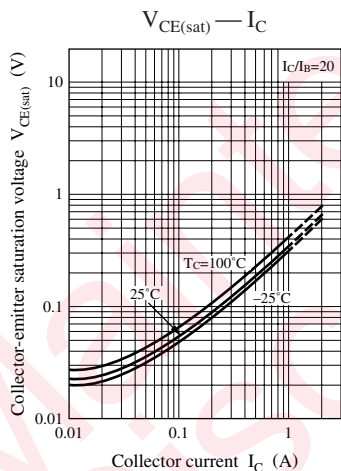
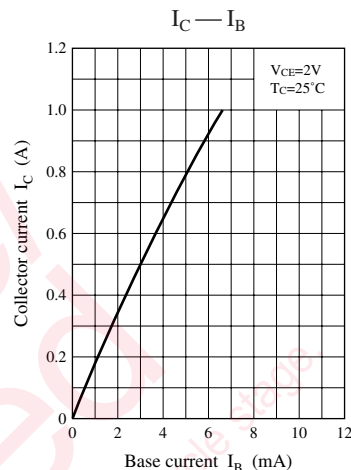
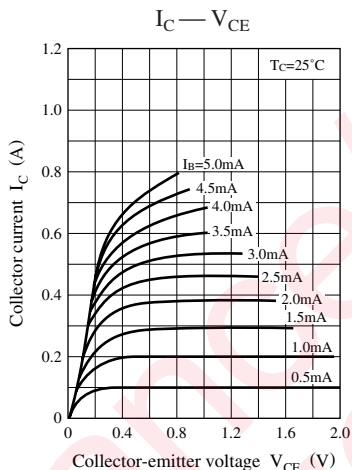
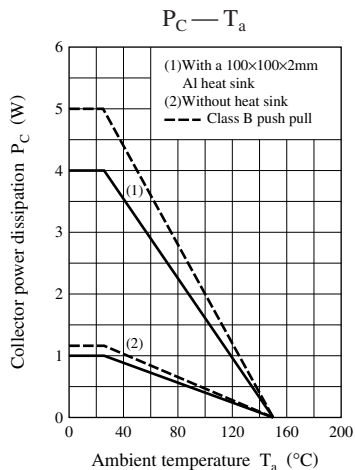
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Collector-base voltage (Emitter open)	V_{CBO}	$I_C = 10 \mu\text{A}$, $I_E = 0$	18			V
Collector-emitter voltage (Base open)	V_{CEO}	$I_C = 1 \text{ mA}$, $I_B = 0$	18			V
Emitter-base voltage (Collector open)	V_{EBO}	$I_E = 10 \mu\text{A}$, $I_C = 0$	5			V
Collector-base cutoff current (Emitter open)	I_{CBO}	$V_{CB} = 10 \text{ V}$, $I_E = 0$			1	μA
Collector-emitter cutoff current (Base open)	I_{CEO}	$V_{CE} = 18 \text{ V}$, $I_B = 0$			10	μA
Forward current transfer ratio	h_{FE1}^*	$V_{CE} = 2 \text{ V}$, $I_C = 500 \text{ mA}$	90		280	—
	h_{FE2}	$V_{CE} = 2 \text{ V}$, $I_C = 1.5 \text{ A}$	50	100		
Collector-emitter saturation voltage	$V_{CE(sat)}$	$I_C = 1 \text{ A}$, $I_B = 50 \text{ mA}$			0.5	V
Base-emitter saturation voltage	$V_{BE(sat)}$	$I_C = 500 \text{ mA}$, $I_B = 50 \text{ mA}$			1.2	V
Transition frequency	f_T	$V_{CB} = 6 \text{ V}$, $I_E = -50 \text{ mA}$, $f = 200 \text{ MHz}$		150		MHz
Collector output capacitance (Common base, input open circuited)	C_{ob}	$V_{CB} = 6 \text{ V}$, $I_E = 0$, $f = 1 \text{ MHz}$		12		pF

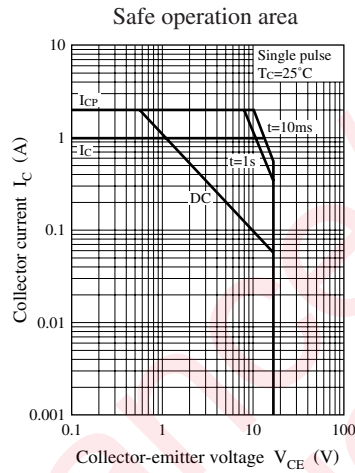
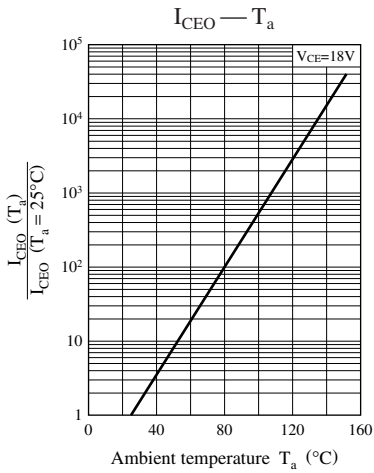
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. *: Rank classification

Rank	Q	R	S
h_{FE1}	90 to 155	130 to 210	180 to 280







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 planned maintenance type
 maintenance type
 planned discontinued type
 discontinued type
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